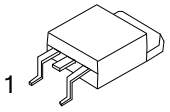
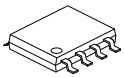
UT15N10

POWER MOSFET

15A, 100V N-CHANNEL POWER MOSFET



TO-252



SOP-8

■ DESCRIPTION

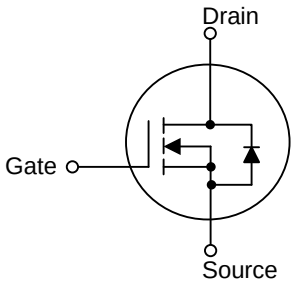
The UTC **UT15N10** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, low gate charge and high switching speed.

The UTC **UT15N10** is suitable for high voltage synchronous rectifier and DC/DC converters, etc.

■ FEATURES

* $R_{DS(ON)}$ ≤ 72 mΩ @ V_{GS}=10V, I_D=7.5A
  $R_{DS(ON)}$ ≤ 84 mΩ @ V_{GS}=4.5V, I_D=7.5A
* High Switching Speed
* High Cell Density Trench Technology

■ SYMBOL



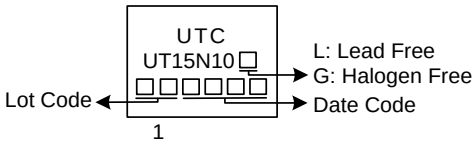
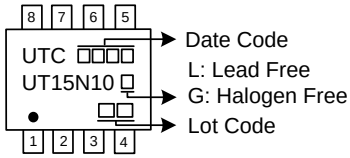
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT15N10L-TN3-R	UT15N10G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UT15N10L-S08-R	UT15N10G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

UT15N10G-TN3-R (1)Packing Type (2)Package Type (3)Green Package	(1) R: Tape Reel (2) TN3: TO-252, S08: SOP-8 (3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING

TO-252	SOP-8
	

■ ABSOLUTE MAXIMUM RATING (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	100	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current	Continuous	I_D	15	A
	Pulsed (Note 2)	I_{DM}	30	A
Avalanche Energy (Note 3)	Single Pulsed (Note 3)	E_{AS}	90	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.25	V/nS
Power Dissipation	TO-252	P_D	71	W
	SOP-8		5	W
Junction Temperature		T_J	+150	°C
Storage Temperature Range		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. L=10mH, I_{AS}=4.25A, V_{DD}=50V, R_G = 25Ω, Starting T_J = 25°C
4. I_{SD} ≤15A, di/dt ≤100A/μs, V_{DD} ≤ $V_{(BR)DSS}$, T_J ≤ 25°C

■ THERMAL DATA (Note.)

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-252	$θ_{JA}$	50	°C/W
	SOP-8		100	°C/W
Junction to Case	TO-252	$θ_{JC}$	2.1	°C/W
	SOP-8		25 (Note)	°C/W

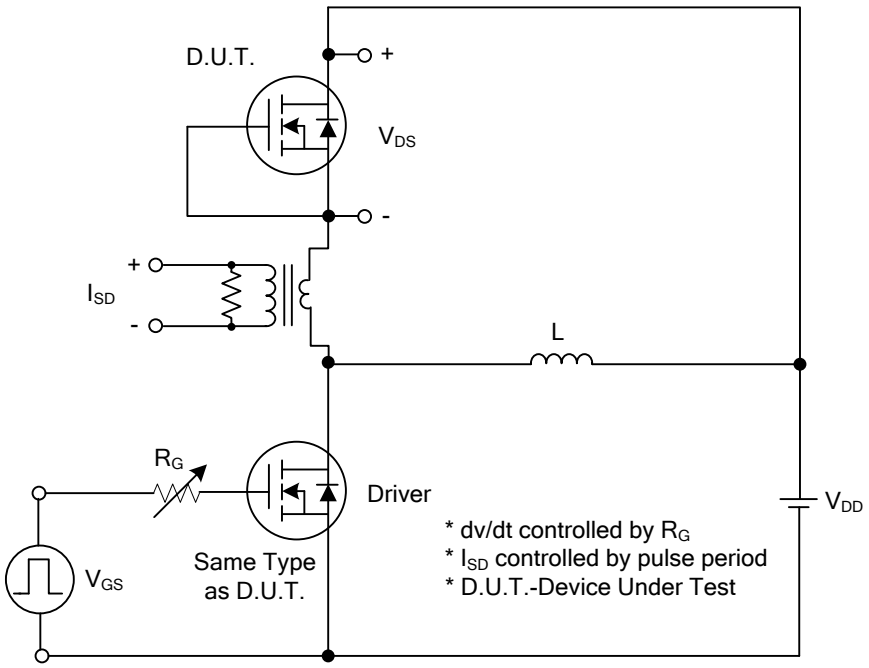
Note: Surface mounted on FR4 board using 1 sq in pad size, (Cu Area 1.127 sq in [2 oz] including traces)..

■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

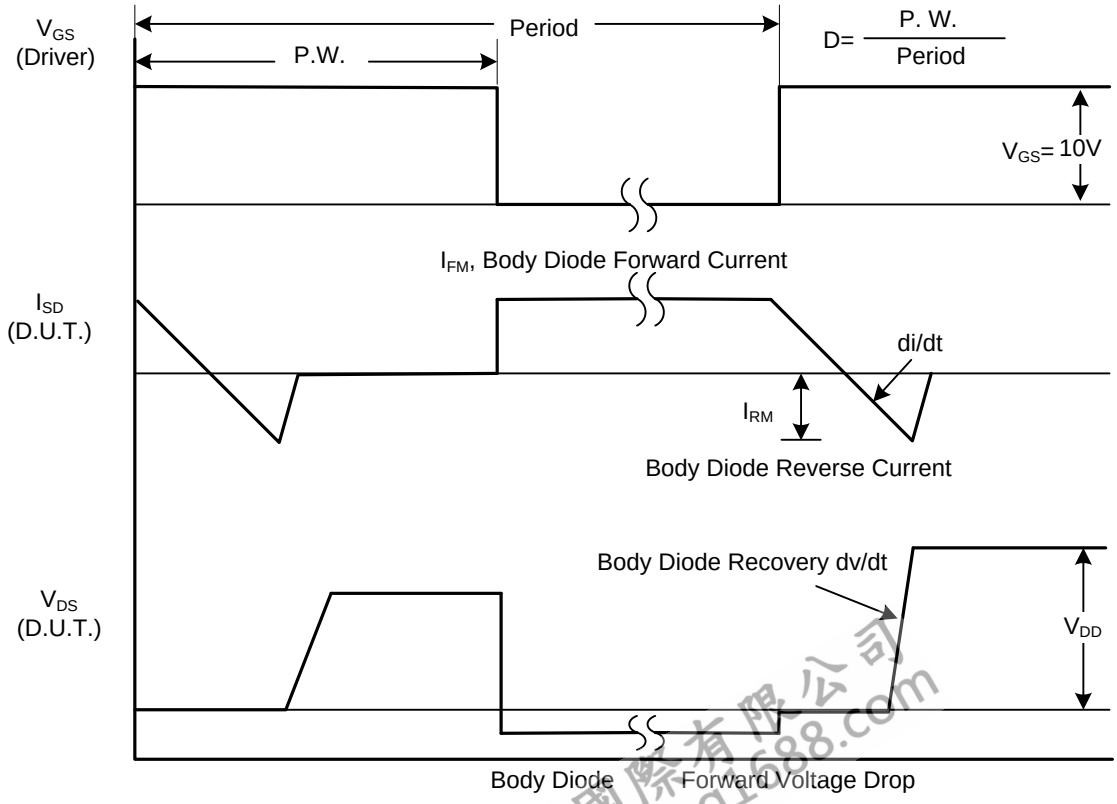
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=250μA, V_{GS}=0V	100			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=100V, V_{GS}=0V			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS}=+20V, V_{DS}=0V			+100	nA
	Reverse		V_{GS}=-20V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	1.0		3.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=7.5A			72	mΩ
			V_{GS}=4.5V, I_D=7.5A			84	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=25V, f=1.0MHz		1088		pF
Output Capacitance		C_{OSS}			78		pF
Reverse Transfer Capacitance		C_{RSS}			68		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=50V, V_{GS}=10V, I_D=5A I_G=1mA (Note 1, 2)		35.6		nC
Gate to Source Charge		Q_{GS}			2.7		nC
Gate to Drain Charge		Q_{GD}			5.8		nC
Turn-on Delay Time (Note 1)		$t_{D(ON)}$	V_{DS}=50V, V_{GS}=10V, I_D =5A, R_G =3Ω (Note 1, 2)		4.8		ns
Rise Time		t_R			15.2		ns
Turn-off Delay Time		$t_{D(OFF)}$			34.4		ns
Fall-Time		t_F			16.4		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				15	A
Maximum Body-Diode Pulsed Current		I_{SM}				30	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S=15A, V_{GS}=0V			1.4	V
Reverse Recovery Time (Note 1)		t_{rr}	I_S=15A, V_{GS}=0V, dI/dt=100A/μs		44		nS
Reverse Recovery Charge		Q_{rr}			39		nC

Notes: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

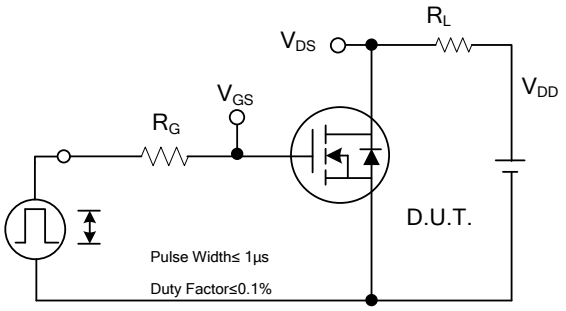


Peak Diode Recovery dv/dt Test Circuit

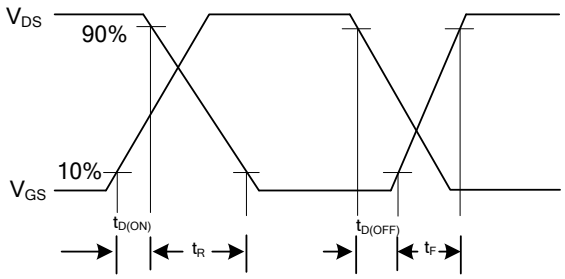


Peak Diode Recovery dv/dt Waveforms

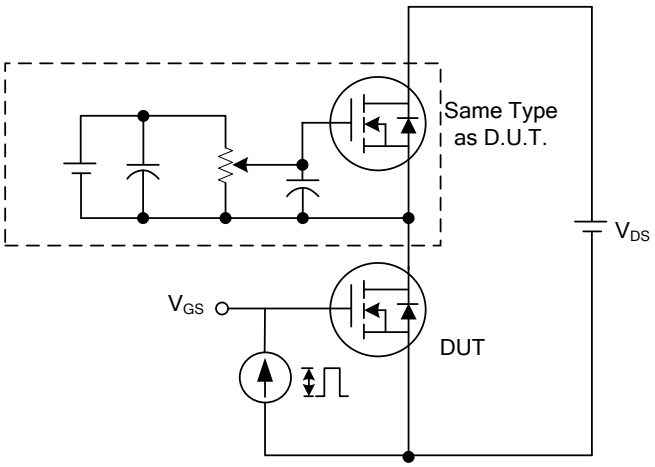
■ TEST CIRCUITS AND WAVEFORMS



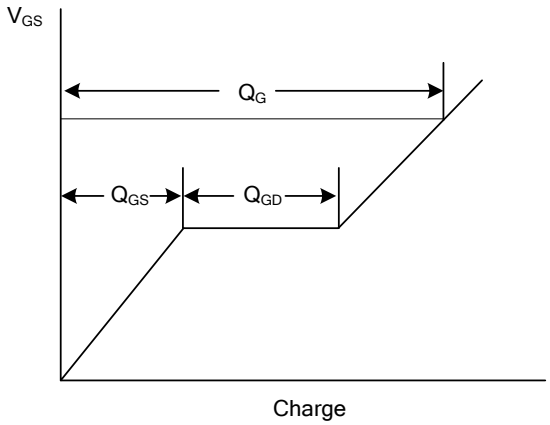
Switching Test Circuit



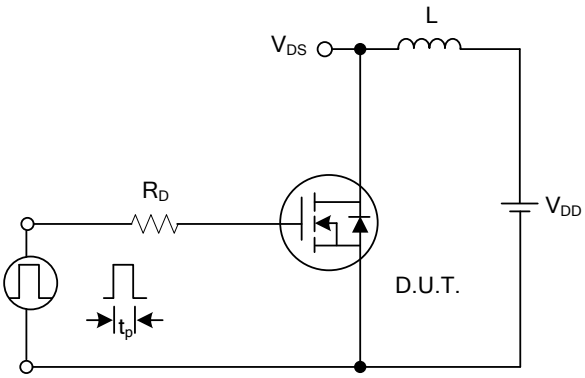
Switching Waveforms



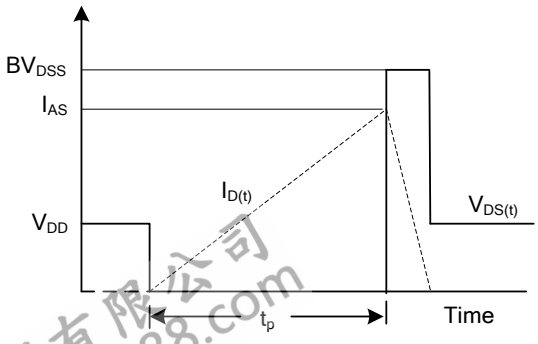
Gate Charge Test Circuit



Gate Charge Waveform



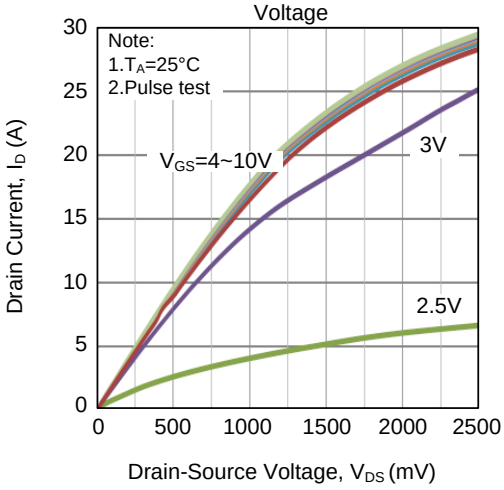
Unclamped Inductive Switching Test Circuit



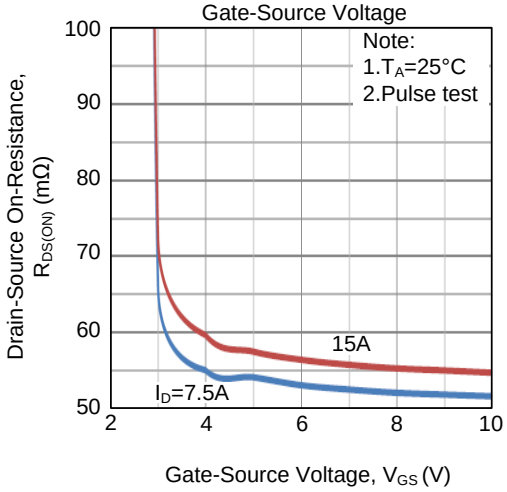
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

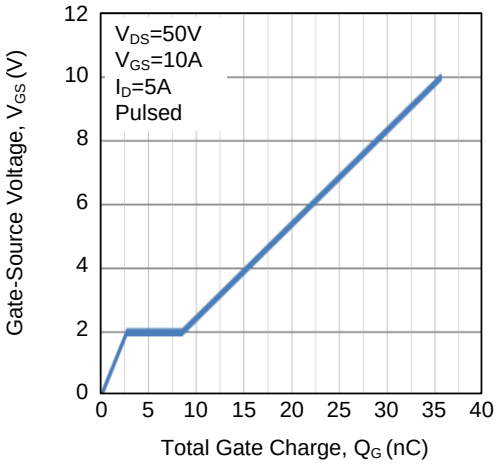
Drain Current vs. Drain-Source Voltage



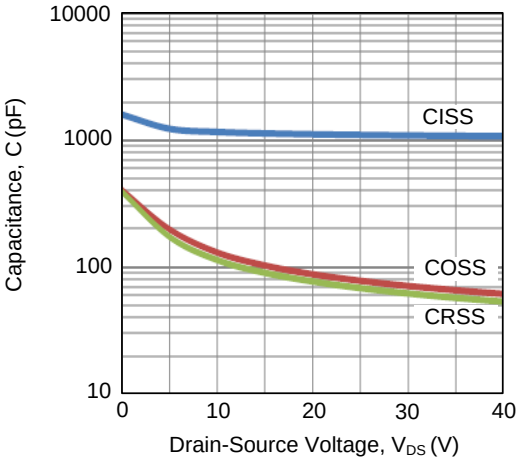
Drain-Source On-Resistance vs. Gate-Source Voltage



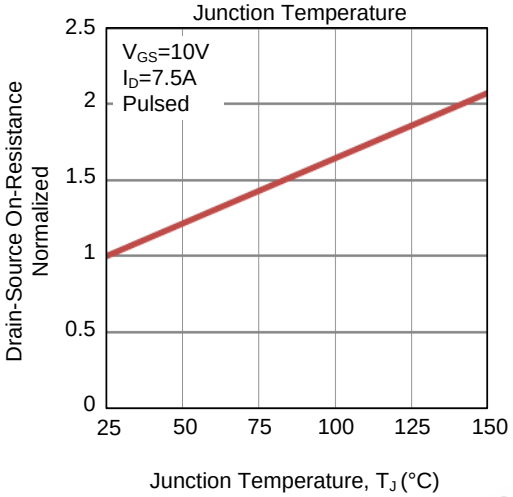
Gate Charge Characteristics



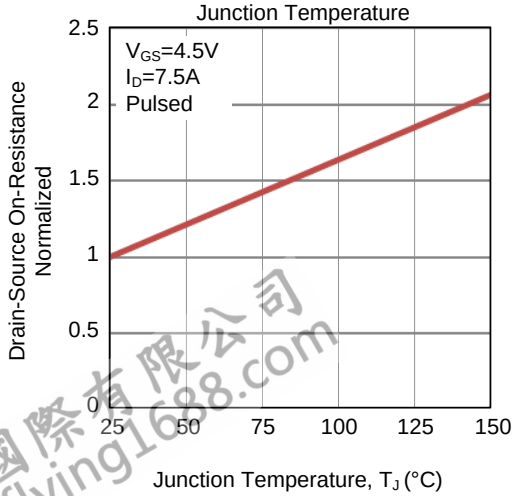
Capacitance Characteristics



Drain-Source On-Resistance vs. Junction Temperature

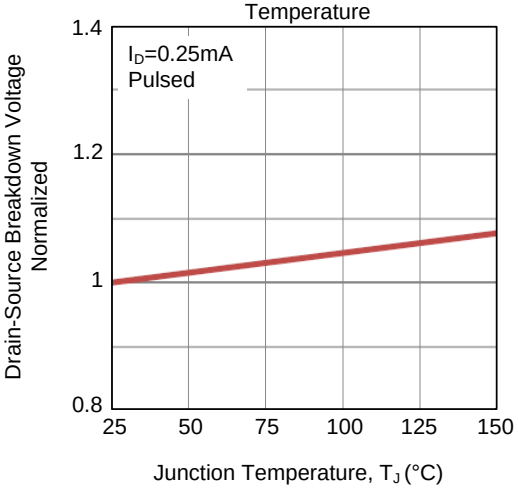


Drain-Source On-Resistance vs. Junction Temperature

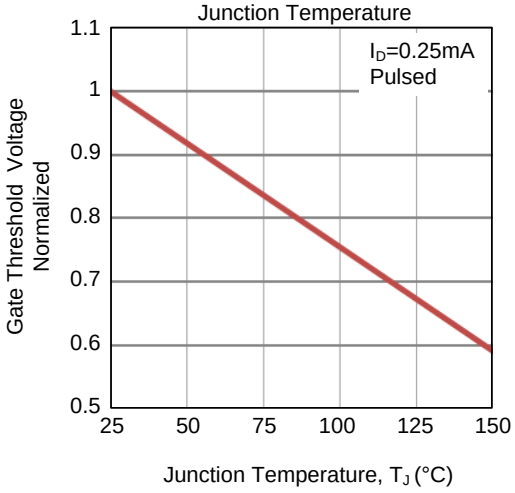


■ TYPICAL CHARACTERISTICS (Cont.)

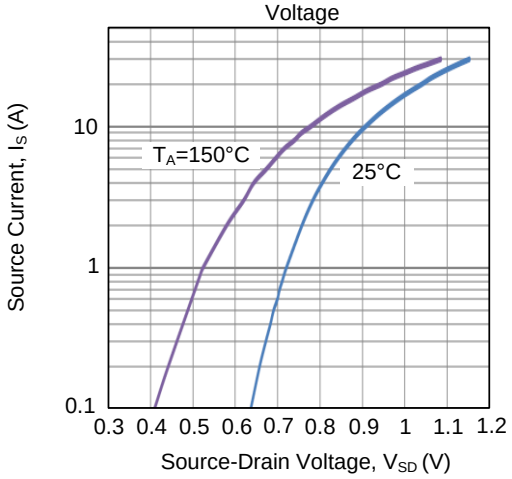
Breakdown Voltage vs. Junction Temperature



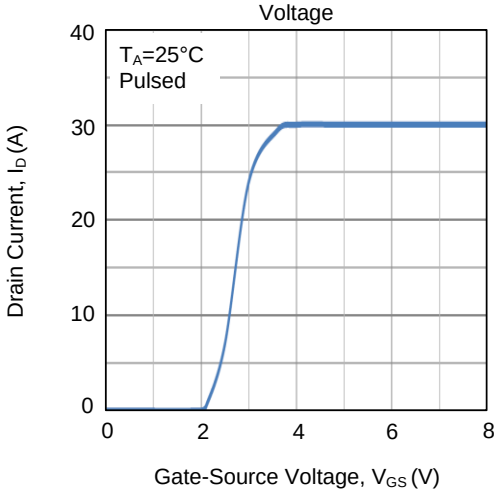
Gate Threshold Voltage vs. Junction Temperature



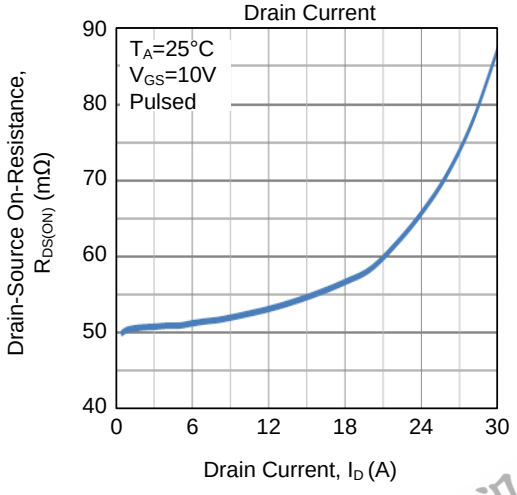
Source Current vs. Source-Drain Voltage



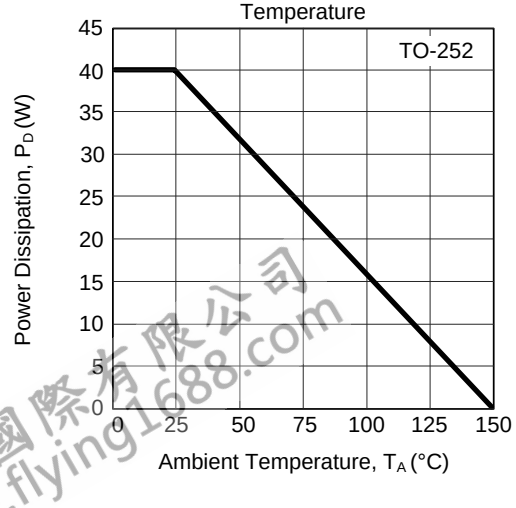
Drain Current vs. Gate-Source Voltage



Drain-Source On-Resistance vs. Drain Current



Power Dissipation vs. Ambient Temperature



■ TYPICAL CHARACTERISTICS (Cont.)